

# DA-683 Series

## Component Compatibility Guide

A list of peripheral components suitable for use with the DA-683 series of computers

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## 1. Introduction

This document lists hardware components that are proven to provide the performance listed in the specification when used with the Moxa DA-683 series of embedded computers, or computers that share basic design features with the DA-683 series. Moxa computers come with multiple peripheral options and are engineered to work with components having different hardware specifications. This flexibility could sometimes lead to compatibility issues. When used with the DA-683 series of embedded computers, peripherals from one manufacturer may not work as well as the ones made by another manufacturer. Moxa provides this list of DA-683 series-compatible components, so that users can be certain of a reliable performance from the DA-683 series, when used with the components listed in this document.

## 2. Testing Methods

To validate that a component meets the Moxa standards for quality and performance, the following five key compatibility tests are run:

- Ambient temperature burn-in
- Low temperature hard start
- Heat/humidity burn-in
- Cyclic high-low temperature burn-in
- Vibration test

### **Ambient Temperature Burn-In**

The component is mounted on to a DA-683 computer and put through a series of stress tests at an ambient temperature of around 25°C, for a specified period of time. The duration of the test is determined based on the class of peripherals being tested.

### **Low Temperature Hard Start**

The component is mounted on to an unpowered DA-683 computer and then the system is booted up at an extremely low temperature. The designated low temperature value depends on the computer model being tested.

### **Heat/Humidity Burn-In**

The component is mounted on to a DA-683 computer, placed in a temperature- and humidity-controlled enclosure, and then put through the burn-in test for a specified period of time. The temperature, humidity, and time targets vary depending on the specification of the computer model used in the test.

### **Cyclic High-Low Temperature Burn-In**

The component is mounted on to a DA-683 computer, placed in a temperature controlled enclosure, and then put through the burn-in test wherein the temperature is cyclically varied from very high to very low and back again, over a specified period of time. The target temperature range and the duration of the test can vary depending on the specification of the computer model used in the test.

### **Vibration Test**

The component is mounted on to a DA-683 computer that is bound inside an electromagnetic vibrator, and then put through random vibration tests along three orthogonal axes: longitudinal, transverse, and vertical. The vibration tests are compliant with the EN50155/IEC61373 vibration standards.

## **3. Storage Endurance**

Storage media, such as SSDs, CF cards, SD cards, Disk on Module, and Cfast, are composed of different electrical components. The main electrical components in these storage media, the NAND-flash memory and NAND-flash controller, impact the storage endurance and lifespan of the storage media.

### **NAND-Flash Memory Endurance**

NAND-flash memories have a limit on the number of times they can be programmed and erased (P/E). The P/E cycle as well as the erase count of the NAND-flash memory can be used to determine this limit. For example, an SLC (single-level cell) flash memory has a 60,000 P/E cycle, an MLC (multi-level cell) flash memory has a 3,000 P/E cycle, and TLC NAND flash memories have P/E cycle values up to 1,000. Each flash memory type has a different endurance level, which is why the storage lifespan is based on the flash memory type. Storage that uses SLC type flash memory could have the best endurance level compared with the MLC type storage. SLC storage usually comes with a 5-year OEM warranty (the actual warranty period depends on the original manufacturer). MLC storage only comes with a 1- to 3-year warranty. The major differences between SLC and MLC are: (a) The SLC NAND flash has a lifespan that is around 20 times that of an MLC, and (b) The price can differ by a factor of 4 to 5. The SLC type of storage is recommended for systems that are expected to have high reliability, and for applications that need to frequently write data to a storage medium.

### **Terabytes Written (TBW)**

TBW is the unit used to evaluate SSD endurance. In actual applications, storage is used for routine operations and data access. Therefore the physical P/E cycle is not appropriate for describing the total rewritable data capacity. The management efficiency of the storage controller also affects the

total rewritable data capacity result. For these reasons, Joint Electron Device Engineering Council (JEDEC) has defined a standard for SSD endurance evaluation called JESD218, which uses TBW to measure the endurance of the storage memory. By referring to this TBW value, users can easily estimate the storage specification and select a suitable storage for real-life use cases. For example, when routine operations need a maximum of 20 GB and the expected storage lifespan is 3 years, the total rewritable data demand would be 21.9 TBW (20 GB x 365 x 3). In this case, a storage that has more than 21.9 TBW will meet the requirement. We recommend selecting a storage media with a TBW that is greater than the calculated value.

## 4. Declaration for Liability Exclusion

The specifications, warranty terms, and liability of items listed in this guide are the sole responsibility of the original manufacturers. Moxa does not take any responsibility in this regard. Please visit the manufacturers' official websites for up-to-date product information before purchasing the components.

## 5. Compatible Components

Peripheral components that have been tested and found suitable for use with the DA-683 series of computers are listed in this section. The following table lists the Test Codes and their descriptions:

Test Code	Description
A	The component has passed the ambient temperature verification test
B	The component has passed the low temperature verification test
C	The component has passed the heat/humidity verification test
D	The component has passed the cyclic high-low temperature verification test
E	The component has not been tested, but is similar to another component that has been tested in terms of its material and design.
F	The component has passed the vibration verification test

## DRAM

Vendor	Memory Size	Moxa's PN	Vendor's PN	Interface	Chip Brand	Speed	Test Codes
DSL	1 GB	1352110012040	D2SH28081XH30AB	DDR2	Hynix	667 MHz	B, C, D
DSL	1 GB	N/A	D2SM64162XH30ABIS	DDR2	Micron	667 MHz	B, C, D
DSL	1 GB	1352110012030	D2SP64162XH30AAIS	DDR2	ProMOS	667 MHz	B, C, D
DSL	1 GB	N/A	D2SP28081XH30ABIS	DDR2	ProMOS	667 MHz	B, C, D
DSL	2 GB	1352110022080	D2SH28082XH30AB	DDR2	Hynix	667 MHz	B, C, D
DSL	2 GB	N/A	D2SM28082XH30ABIS	DDR2	Micron	667 MHz	B, C, D
DSL	2 GB	1352110022070	D2SP28082XH30ABIS	DDR2	ProMOS	667 MHz	B, C, D
InnoDisk	1 GB	N/A	M2SK-1GHF5C06-J	DDR2	Hynix	800 MHz	B, C, D
InnoDisk	1 GB	N/A	M2SJ-1GPF5W05-BA31	DDR2	ProMOS	667 MHz	B, C, D
InnoDisk	1 GB	N/A	M2SK-1GPF5J6-BA31	DDR2	ProMOS	667 MHz	B, C, D
Transcend	1 GB	N/A	TS128MSQ64V8U	DDR2	Samsung	800 MHz	E
Transcend	2 GB	N/A	TS256MSQ64V8U	DDR2	Samsung	800 MHz	A
Unigen	1 GB	N/A	UG12T6400L8SU-6AP	DDR2	Hynix	667 MHz	B, C, D
Unigen	1 GB	N/A	UG12T6408M8SU-6AS	DDR2	ProMOS	667 MHz	B, C, D
Unigen	2 GB	N/A	UG25T6400M8SU-8CP-000-00	DDR2	Hynix	800 MHz	B, C, D

**DOM**

Vendor	Storage Size	Moxa's PN	Vendor's PN	Flash Memory Brand	Flash Memory Spec	Controller	Firmware	Warranty	Warranty Exclusion	Test Codes
InnoDisk	2 GB	N/A	DE4H-02GD31W1DR-A31	Samsung	SLC	N/A	N/A	5 years	Endurance > 60,000	B, C, D
InnoDisk	2 GB	1352020022080	DE4H-02GD31W1DB-A31	N/A	SLC	N/A	N/A	5 years	Endurance > 60,000	B, C
InnoDisk	4 GB	N/A	DE4H-04GD31W1DR-A31	Samsung	SLC	N/A	N/A	5 years	Endurance > 60,000	B, C, D
InnoDisk	8 GB	N/A	DE4H-08GD31W1D-A31	Samsung	SLC	N/A	N/A	5 years	Endurance > 60,000	B, C, D
Memoright	1 GB	N/A	MRDEM2B001GB7P1IA0	Samsung	SLC	SM2232	K0407	5 years	N/A	E
Memoright	2 GB	N/A	MRDEM2B002GB8P1IA0	Samsung	SLC	SM2232	K1124	5 years	N/A	B, C, D
Memoright	4 GB	N/A	MRDEM2B004GB0P1IA0	Samsung	SLC	SM2232	K0407	5 years	N/A	B, C, D
Memoright	8 GB	N/A	MRDEM2B008GN2P1IA0	Micron	SLC	SM2232	K0407	5 years	N/A	B, C, D
Memoright	16 GB	N/A	MRDEM2B016GN4P1IA0	Micron	SLC	N/A	N/A	5 years	N/A	B, C, D
Memoright	32 GB	N/A	MRDEM2B032GN5P1IA0	Micron	SLC	SM2232	K0407	5 years	N/A	B, C, D
Transcend	1 GB	N/A	TS1GDOM44V-S	Samsung	SLC	SM223 AC	N/A	2 years	N/A	E
Transcend	2 GB	N/A	TS2GPTM510-44V	Samsung	SLC	SM2231 AD	N/A	2 years	N/A	E
Transcend	4 GB	N/A	TS4GPTM510-44V	Samsung	SLC	SM2231 AD	N/A	2 years	N/A	E
Transcend	8 GB	N/A	TS8GPTM510-44V	Samsung	SLC	SM2231 AD	N/A	2 years	N/A	A

CF										
Vendor	Storage Size	Moxa's PN	Vendor's PN	Flash Memory Brand	Flash Memory Spec	Controller	Firmware	Warranty	Warranty Exclusion	Test Codes
Apacer	4 GB	N/A	AP-CF004GL9FS-NR	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	E
Apacer	8 GB	N/A	AP-CF008GLAFS-NR	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	E
Apacer	8 GB	N/A	AP-CF008GL9FS-NR	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	E
Apacer	16 GB	N/A	AP-CF016GLAFS-NR	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	E
Apacer	16 GB	N/A	AP-CF016GL9FS-NR	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	E
Apacer	32 GB	N/A	AP-CF032GLAFS-NR	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	A
Apacer	32 GB	N/A	AP-CF032GL9FS-NR	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	A
Memoright	1 GB	N/A	MRCFM2A001GB6C1IA0	Samsung	SLC	SMI2232	K1124	5 years	N/A	E
Memoright	2 GB	N/A	MRCFM2A002GB8C1IA0	Samsung	SLC	SMI2232	K1124	5 years	N/A	E
Memoright	4 GB	N/A	MRCFM2A004GB0C1IA0	Samsung	SLC	SM2232	K1124	5 years	N/A	B, C, D
InnoDisk	4 GB	1352010042130	DC1M-04GD31W1DB	Toshiba	SLC	N/A	N/A	5 years	N/A	B, C, D
Transcend	128 MB	N/A	TS128MCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	256 MB	N/A	TS256MCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	512 MB	N/A	TS512MCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	1 GB	N/A	TS1GCF133	Micron	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	1 GB	N/A	TS1GCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	2 GB	N/A	TS2GCF133	Micron	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	2 GB	N/A	TS2GCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	4 GB	N/A	TS4GCF133	Micron	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	4 GB	N/A	TS4GCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	A
Transcend	8 GB	N/A	TS8GCF400	Micron	MLC	SM2236AC	N/A	2 years	N/A	E
Transcend	8 GB	N/A	TS8GCF133	Micron	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	8 GB	N/A	TS8GCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	16 GB	N/A	TS16GCF1000	Micron	MLC	SM2232ENAC	N/A	2 years	N/A	E
Transcend	16 GB	N/A	TS16GCF400	Micron	MLC	SM2236AC	N/A	2 years	N/A	E
Transcend	16 GB	N/A	TS16GCF133	Micron	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	16 GB	N/A	TS16GCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	32 GB	N/A	TS32GCF1000	Micron	MLC	SM2236AC	N/A	2 years	N/A	A
Transcend	32 GB	N/A	TS32GCF400	Micron	MLC	SM2236AC	N/A	2 years	N/A	A
Transcend	32 GB	N/A	TS32GCF133	Micron	MLC	SM2232AD	N/A	2 years	N/A	E
Transcend	32 GB	N/A	TS32GCF200I	Samsung	MLC	SM2232AD	N/A	2 years	N/A	A



<b>SSD</b>										
<b>Vendor</b>	<b>Storage Size</b>	<b>Moxa's PN</b>	<b>Vendor's PN</b>	<b>Flash Memory Brand</b>	<b>Flash Memory Spec</b>	<b>Controller</b>	<b>Firmware</b>	<b>Warranty</b>	<b>Warranty Exclusion</b>	<b>Test Codes</b>
Apacer	64 GB	N/A	AP64GAS510SB	N/A	MLC	N/A	N/A	2 years	Endurance > 3,000	A
Memoright	64 GB	N/A	MRSAJ6Q064GN225I00	Samsung	SLC	JMF612	MRV1.1.6	5 years	N/A	B, C, D
Transcend	16 GB	N/A	TS16GSSD500	Samsung	SLC	JM616	120820	2 years	N/A	E
Transcend	32 GB	N/A	TS32GSSD500	Samsung	SLC	JM616	120820	2 years	N/A	E
Transcend	64 GB	N/A	TS64GSSD320	Micron	MLC	SF2281	N/A	2 years	N/A	E
Transcend	64 GB	N/A	TS64GSSD500	Samsung	SLC	JM616	120820	2 years	N/A	A
Transcend	128 GB	N/A	TS128GSSD320	Micron	MLC	SF2281	N/A	2 years	N/A	E
Transcend	256 GB	N/A	TS256GSSD320	Micron	MLC	SF2281	N/A	2 years	N/A	A

<b>HDD</b>						
<b>Vendor</b>	<b>Storage Size</b>	<b>Moxa's PN</b>	<b>Vendor's PN</b>	<b>Controller</b>	<b>Firmware</b>	<b>Test Code</b>
HGST	500 GB	N/A	HTS725050A7E630 / 0J38075	N/A	N/A	A
HGST	1 TB	N/A	HCC541010A9E680	N/A	N/A	A
HGST	1 TB	N/A	HTS541010A9E680	N/A	N/A	A
HGST	1 TB	N/A	HTS721010A9E630 / 0J22423	N/A	N/A	A
HGST	1 TB	N/A	HTS541010A9E650	N/A	N/A	A
Samsung	2 TB	N/A	ST2000LM003	N/A	N/A	A
WD	750 GB	N/A	WD7500BPKT	N/A	N/A	A
WD	1 TB	N/A	WD10JUCT	N/A	N/A	A
WD	1 TB	N/A	WD10JPVT	N/A	N/A	A
WD	1 TB	N/A	WD10SPCX	N/A	N/A	A